



#### Product Summary (@ T<sub>A</sub> = +25°C)

V <sub>RRM</sub> (V)	I <sub>O</sub> (A)	V <sub>F(MAX)</sub> (mV)	I <sub>R(MAX)</sub> (μ <b>A</b> )
50	5	520	300

## **Features and Benefits**

- Low Leakage Current
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Applications**

- SMPS
- AC-DC
- DC-DC Converter
- Freewheeling Diodes

#### **Mechanical Data**

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish.). Solderable per MIL-STD-202, Method 208 (3)
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (Approximate)



Top View



Bottom View

### Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
SDT5A50SA-13	Commercial	SMA	5,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

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4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# **Marking Information**



DV5 = Product Type Marking Code

| Manufacturers' Code Marking

| YWW = Date Code Marking
| Last Digit of Year (ex: 8 for 2018)

| WW = Week Code 01 to 52
| XX = Foundry and Assembly Site

Note: 5. Device has a cathode band (as shown above) and may also have a cathode notch.



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	50	<b>V</b>
Average Rectified Output Current	I <sub>O</sub>	5	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	50	Α

## **Thermal Characteristics**

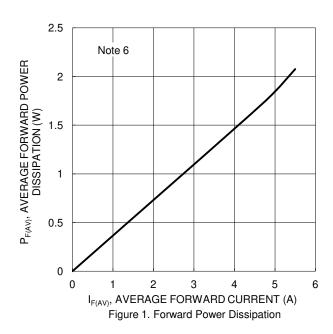
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Ambient (Note 6) Thermal Resistance Junction to Case (Note 6)	R <sub>θ</sub> JA R <sub>θ</sub> JC	65 25	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

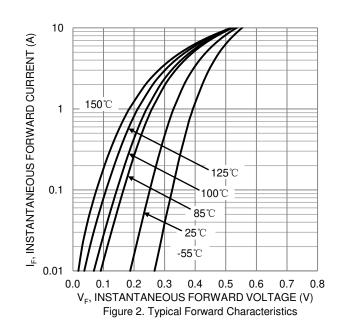
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	_	0.44 0.37	0.52 0.45	V	I <sub>F</sub> = 5.0A, T <sub>J</sub> = +25°C I <sub>F</sub> = 5.0A, T <sub>J</sub> = +125°C
Leakage Current (Note 7)	I <sub>R</sub>	_	60 20	300 90	μA mA	V <sub>R</sub> = 50V, T <sub>J</sub> = +25°C V <sub>R</sub> = 50V, T <sub>J</sub> = +125°C

Notes:

- 6. Device mounted on FR-4 substrate, 0.4"\*0.5", 2oz, single-sided, PC boards with 0.2"\*0.25" copper pad.
- 7. Short duration pulse test used to minimize self-heating effect.







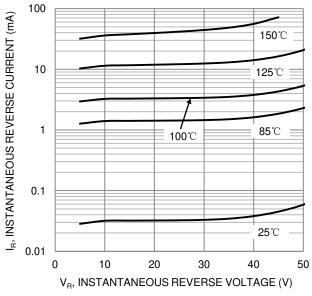


Figure 3. Typical Reverse Characteristics

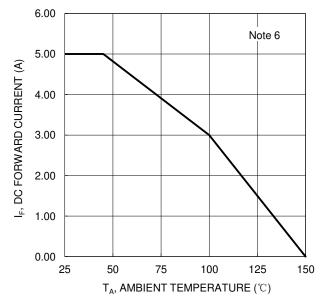


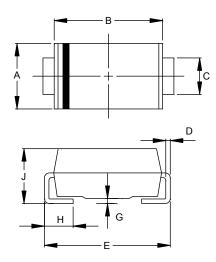
Figure 4. DC Forward Current Derating



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SMA

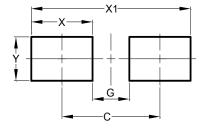


SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
E	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	1.96	2.40		
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SMA



Dimensions	value	
Difficusions	(in mm)	
С	4.00	
G	1.50	
Х	2.50	
X1	6.50	
Υ	1.70	



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